

PATENTS ONLY



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JCE72 U.S. PTO  
09/878424



To the Honorable Commissioner of Patents and Trademarks:  
Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

Yuichi MATSUDA  
Mikio HASHIMOTO  
Ikunori SAKAI

06/12/01

2. Name and address of receiving party(ies):

Name: GRAND POLYMER CO., LTD.

Internal Address:

Additional name(s) of conveying party(ies) attached?  Yes  No

3. Nature of Conveyance

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

Execution Date: May 30, 2001

Street Address: 18-1, Kyobashi 1-Chome

Chuo-ku

City: Tokyo State: Japan ZIP: 104-0031

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: May 30, 2001

A. Patent Application No.(s)

09/878424

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SHERMAN & SHALLOWAY

Internal Address: \_\_\_\_\_

Street Address: \_\_\_\_\_

413 North Washington Street

City: Alexandria State: VA

ZIP: 22314

6. Total number of applications and patents involved:..... [ 1 ]

7. Total fee (37 CFR 3.41).....\$40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document

Leonard W. Sherman  
Name of Person Signing

Signature June 12, 2001  
Date

Total number of pages including cover sheet, attachments, and document [ 2 ]

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03 FC:581

40.00 DP

A S S I G N M E N T

WHEREAS, We, Yuichi MATSUDA ; Mikio HASHIMOTO and Ikunori SAKAI

residing at Sodegaura-Shi, Chiba, Japan ; Sodegaura-Shi, Chiba, Japan and Sodegaura-Shi, Chiba, Japan

, (hereafter referred to as Inventors), have invented certain new and useful improvements in FLAME-RETARDING THERMOPLASTIC RESIN COMPOSITION

for which an application for United States Letters Patent was signed by us on even date herewith; and

WHEREAS, GRAND POLYMER CO., LTD. a corporation of Japan, having a place of business at 18-1, Kyobashi 1-Chome, Chuo-Ku, Tokyo, 104-0031 Japan (hereafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents do sell, assign and transfer unto said Company the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the said Company, its successors and assigns.

FURTHER, We agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Company, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, We have hereunto set our hands this 30th day of May, 2001

Signed in the presence of:

Witness: Masao Katsura
Witness: Masao Katsura
Witness: Masao Katsura
Witness:
Witness:
Witness:

Signed: Yuichi Matsuda
Signed: Mikio Hashimoto
Signed: Ikunori Sakai
Signed:
Signed:
Signed: